## DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

As a below named inventor, I hereby declare that:						
My residence, post office address, and citizenship are as stated below next to my name.						
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:						
Photosensitive composition for interlayer dielectric and method of forming patterned interlayer dielectric						
the specification of which [X] is attached hereto OR						
[ ] was filed on, United States Application Number or PCT International Application Number and was amended on (if applicable).						
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment specifically referred to above.  I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.						
I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 365(a) of any PCT International application which designated at least one county other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or of any PCT International application having a filing date before that of the application on which priority is claimed.						
Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YY)	Priority Claimed			
JP 2002-239130	Japan	08/20/2002	[x] Yes [ ] No			
I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.						
Application Number(s)	Filing Date (MM/DD/YY)	[ ] Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.				
International application desi each of the claims of this app the manner provided by the f material to patentability as de	gnating the United States of A plication is not disclosed in the first paragraph of 35 U.S.C. 11	ed States application(s), or 36 america, listed below and, inso prior United States or PCT In 12, I acknowledge the duty to became available between the pot this application.	ofar as the subject matter of nternational application in disclose information which is			

10/524537

U.S. Parent Application or PCT Parent Number	Parent Filing Date (MM/DD/YY)	Parent Patent Number (if applicable)
PCT/JP03/08928	07/14/2003	

As a named inventor, I hereby appoint the following registered practioner(s), respectively and individually, as my attorneys and/or agents, with full power of substitution and revocation, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office:

## **CUSTOMER NUMBER 26,289**

Direct all correspondence to:	AZ ELECTRONIC MATERIALS USA CORP. Industrial Property Department 70 Meister Avenue
	Somerville, NJ 08876 Telephone: 908/429-3536 Facsimile: 908/429-3650

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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